



MAIL STOP AMENDMENT

PATENT
7372/88130

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Masahiko HATA et al. Confirmation: 4111
Serial No.: 10/577,069 Art Unit: 2891
Filed: June 20, 2006 Examiner: J. Slutsker
For: Method for manufacturing compound semiconductor substrate

AMENDMENT

Commissioner for Patents
P. O. Box 1450
Alexandria, VA 22313-1450

Monday, December 29, 2008

(Thurs., Dec. 25 = Christmas, Dec. 26 = PTO closed)

Sir:

This Amendment responds to the Office Action of June 25, 2008. The response date has been extended by petition for extension of time.

Amendments to the specification begin at page 2.

Drawings – request to enter new Fig. 7 is on page 3.

Amendments to the claims begin on page 4.

Remarks begin on page 7.

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